

HS97	Description	Base		Implementation	Present		Concession		ODCs
		rate	Bound rate		concession established	INR GATT Schedule	INRs	incorporated in a	
8541.10 10 00	Chips,dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let				0
8541.10 90 00	Other	8.0	0.0	2000	WT/Let				0
8541.2	Transistors, other than photosensitive transistors:								
8541.21 10 00	Chips,dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let				0
8541.21 90 00	Other	8.0	0.0	2000	WT/Let				0
8541.29	Other								
8541.29 10 00	Chips,dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let				0
8541.29 90 00	Other	8.0	0.0	2000	WT/Let				0
8541.30	Thyristors, diacs and triacs, other than photosensitive devices								
8541.30 10 00	Chips,dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let				0
8541.30 20 00	Thyristors	8.0	0.0	2000	WT/Let				0
8541.30 30 00	Diacs	8.0	0.0	2000	WT/Let				0
8541.30 40 00	Triacs	8.0	0.0	2000	WT/Let				0
8541.40	Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes								
8541.40 10 00	Chips,dice and wafers not yet cut into chips	10.0	0.0	2000	WT/Let				0
8541.40 20	Light emitting diodes								
8541.40 20 10	Laser devices	10.0	0.0	2000	WT/Let				0
8541.40 20 90	Other	10.0	0.0	2000	WT/Let				0
8541.40 90	Other								
8541.40 90 10	Photovoltaic cells	8.0	0.0	2000	WT/Let				0
8541.40 90 20	Photovoltaic cells (photovoltaic cells, including solar cells, photodiodes, photocouples and photorelays	8.0	0.0	2000	WT/Let				0

HS97	Description	Base		Implementation	Present		Concession first	
		rate	Bound rate		concession established	INCORPORATED IN A SCHEDULE	Earlier INRs	ODCs
8541.40.90.30	Charge coupled devices (CCD)	10.0	0.0	2000	WT/Let			0
8541.40.90.90	Other	10.0	0.0	2000	WT/Let			0
8541.50	Other semiconductor devices							
8541.50.10.00	Chips, dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let			0
8541.50.20.00	Rectifier devices	8.0	0.0	2000	WT/Let			0
8541.50.90.00	Other	8.0	0.0	2000	WT/Let			0
8541.60	Mounted piezo-electric crystals							
8541.60.10.00	Crystal vibrator	8.0	0.0	2000	WT/Let			0
8541.60.90.00	Other	8.0	0.0	2000	WT/Let			0
8541.90	Parts							
8541.90.10.00	A. Lead frames	4.0	0.0	2000	WT/Let			0
8541.90.20.00	B. Of diodes	8.0	0.0	2000	WT/Let			0
8541.90.30.00	C. Of transistors	8.0	0.0	2000	WT/Let			0
8541.90.90.00	D. Other	8.0	0.0	2000	WT/Let			0
8542	Electronic integrated circuits and microassemblies.							
8542.1	Monolithic digital integrated circuits:							
8542.12.00.00	Cards incorporating an electronic integrated circuit ('smart' cards)	8.0	0.0	2000	WT/Let			0
8542.13	Metal oxide semiconductors (MOS technology)							
8542.13.10.00	Central processing unit (CPU) for computer	8.0	0.0	2000	WT/Let			0
8542.13.90.00	Other	8.0	0.0	2000	WT/Let			0
8542.14.00.00	Bipolar	8.0	0.0	2000	WT/Let			0
8542.19	Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)							
8542.19.10.00	Chips, dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let			0
8542.19.90	Other							

HS97	Description	Base		Implementation	Present		Concession first	
		rate	Bound rate		concession established	INR GATT Schedule	Earlier INRs	ODCs
8542.19 90 10	Memory devices	8.0	0.0	2000	WT/Let			0
8542.19 90 20	Central processing unit (CPU) for computer	8.0	0.0	2000	WT/Let			0
8542.19 90 90	Other	8.0	0.0	2000	WT/Let			0
8542.30	-Other monolithic integrated circuits							
8542.30 10 00	Chips, dice and wafers not yet cut into chips	8.0	0.0	2000	WT/Let			0
8542.30 90 00	Other	8.0	0.0	2000	WT/Let			0
8542.40 00 00	Hybrid integrated circuits	8.0	0.0	2000	WT/Let			0
8542.50 00 00	Electronic microassemblies	8.0	0.0	2000	WT/Let			0
8542.90	Parts							
8542.90 10 00	Lead frames	8.0	0.0	2000	WT/Let			0
8542.90 90 00	Other	8.0	0.0	2000	WT/Let			0
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter.							
8543.1	Particle accelerators:							
8543.11 00 00	Ion implanters for doping semiconductor materials	15.8	0.0	2000	WT/Let			0
8543.8	Other machines and apparatus:							
8543.81 00 00	Proximity cards and tags	15.8	0.0	2000	WT/Let			0
8543.89	Other							
8543.89 20 00	Electrical machines with transition or dictionary functions	23.6	0.0	2000	WT/Let			0
8543.90	Parts							
8543.90 10	For the purpose of semiconductor manufacturing							
8543.90 10 10	Of ion implanters for doping semiconductor materials	15.8	0.0	2000	WT/Let			0
8543.90 90	Other							

HS97	Description	Base rate	Bound rate	Implementation	Present		Concession Inst		
					concession established	WT/Let	INR GATT Schedule	Earlier INRs	ODCs
8543.90.90.10	Flat panel displays for electrical machines with transition or dictionary functions (including LCD, Electro Luminescence, Plasma and other technologies)	15.8	0.0	2000					0
8543.90.90.20	Printed Circuit Assemblies for electrical machines with transition or dictionary functions, which consist of one or more printed circuits of heading No. 8534	15.8	0.0	2000	WT/Let				0
8544	Insulated (including enamelled or anodised) wire, cable (including co-axial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fibre cables, made up of individually sheathed fibres, whether or not assembled with								
8544.4	Other electric conductors, for a voltage not exceeding 80 V:								
8544.41	Fitted with connectors								
8544.41.10	Paper insulated wire								
8544.41.10.10	Of a kind used for telecommunications	17.8	0.0	2000	WT/Let				0
8544.41.20	Plastic insulated wire								
8544.41.20.10	Of a kind used for telecommunications	17.8	0.0	2000	WT/Let				0
8544.41.90	Other								
8544.41.90.10	Of a kind used for telecommunications	17.8	0.0	2000	WT/Let				0
8544.49	Other								

HS97	Description	Base rate		Implementation	Present concession		Concession first incorporated in a		ODCs
		rate	Bound rate		established	INR	GATT Schedule	Earlier INRs	
8544.49 10	Paper insulated wire	17.8	0.0	2000	WT/Let				0
8544.49 10 10	Of a kind used for telecommunications								
8544.49 20	Plastic insulated wire	17.8	0.0	2000	WT/Let				0
8544.49 20 10	Of a kind used for telecommunications								
8544.49 90	Other	17.8	0.0	2000	WT/Let				0
8544.49 90 10	Of a kind used for telecommunications								
8544.5	Other electric conductors, for a voltage exceeding 80 V but not exceeding 1,000 V:								
8544.51	Fitted with connectors								
8544.51 10	Rubber insulated wire	17.8	0.0	2000	WT/Let				0
8544.51 10 10	Of a kind used for telecommunications								
8544.51 20	Plastic insulated wire	17.8	0.0	2000	WT/Let				0
8544.51 20 10	Of a kind used for telecommunications								
8544.51 90	Other	17.8	0.0	2000	WT/Let				0
8544.51 90 10	Of a kind used for telecommunications								
8544.70 00 00	Optical fibre cables	14.4	0.0	2000	WT/Let				0
9009	Photo-copying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus.								
9009.1	Electrostatic photo-copying apparatus:								
9009.11 00 00	Operating by reproducing the original image directly onto the copy (direct process)	19.8	0.0	2000	WT/Let				0
9009.2	Other photo-copying apparatus:								
9009.21 00 00	Incorporating an optical system	19.8	0.0	2000	WT/Let				0
9009.90 00 00	Parts and accessories	19.8	0.0	2000	WT/Let				0

HS97	Description	Base		Implementation	Present		Concession/first		
		rate	Bound rate		concession established	INCORPORATED IN a GATT Schedule	Earlier INRs	ODCs	
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials), not specified or included elsewhere in this Chapter; negatosco								
9010.4	Apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials:								
9010.41 00 00	Direct write-on-wafer apparatus	12.0	0.0	2000		WT/Let			0
9010.42 00 00	Step and repeat aligners	12.0	0.0	2000		WT/Let			0
9010.49 00 00	Other	12.0	0.0	2000		WT/Let			0
9010.50	Other apparatus and equipment for photographic (including cinematographic) laboratories; negatoscopes								
9010.50 10 00	Developing apparatus for semiconductor manufacturing	19.8	0.0	2000		WT/Let			0
9010.90	Parts and accessories								
9010.90 10	For the purpose of semiconductor manufacturing								
9010.90 10 10	Of the apparatus of subheadings Nos. 9010.41 to 9010.49, 9010.50, 1000	12.0	0.0	2000		WT/Let			0
9011	Compound optical microscopes, including those for photomicrography, cinephotomicrography or microprojection								
9011.10	Stereoscopic microscopes								

HS97	Description	Base Bound		Implementation	Present		Concession III/ST	
		rate	rate		concession established	INR GATT Schedule	Earlier INRs	ODCs
9011.10 10 00	Fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	15.8	0.0	2000	WT/Let			0
9011.20	Other microscopes, for photomicrography, cinephotomicrography or microprojection							
9011.20 10	For photomicrography							
9011.20 10 10	Fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	15.8	0.0	2000	WT/Let			0
9011.90	Parts and accessories							
9011.90 10 00	Of subheading Nos. 9011.10.1000, 9011.20.1010	15.8	0.0	2000	WT/Let			0
9012	Microscopes other than optical microscopes ; diffraction apparatus							
9012.10	Microscopes other than optical microscopes and diffraction apparatus							
9012.10 10	Microscopes							
9012.10 10 10	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	14.4	0.0	2000	WT/Let			0
9012.90	Parts and accessories							
9012.90 10 00	Of subheading No. 9012.10.1010	15.8	0.0	2000	WT/Let			0